



PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Farnworth et al.

Serial No.: 10/624,766

Filed: July 22, 2003

For: HERMETIC CHIP IN WAFER FORM
(as amended)

Confirmation No.: 6771

Examiner: T. Magee

Group Art Unit: 2811

Attorney Docket No.: 2269-2741.6US
(95-0804.06/US)

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*Approved
for entry
C. Lee*

**EDDIE LEE
SUPERVISORY PATENT EXAMINER
TECHNOLOGY CENTER 2800**

AMENDMENT PURSUANT TO 37 C.F.R. § 1.312(a)

Mail Stop ISSUE FEE
Commissioner for Patents
P.O. Box 1450
Alexandria, Virginia 22313-1450

Sir:

Please amend the above-referenced application as follows:

Amendments to the Specification begin on page 3 of this paper.